LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER :		
MODULE NO.:	WO320240E	-TFH-V#
APPROVED BY:		
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2021/10/21		First issue

Winstar Display Co.,				MODLE NO :
華凌光電股份有限公司				
RECORDS OF REVISION				DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.		SUMMARY
0	2021/10/21		Fi	rst issue

Contents

- 1.Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 320 * 240 dot

Model serials no.

 \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y \rightarrow LED$, Yellow Green $X \rightarrow LED$, Dual color $G \rightarrow LED$, Green $C \rightarrow LED$, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00 B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

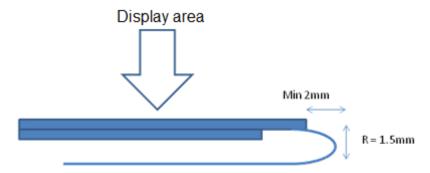
E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in positive voltage

#:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit				
Number of dots	320x240	_				
Outline dimension	94.7 x 83.3 x 9.4max	mm				
View area	81.4 x 61.0	mm				
Active area	76.785 x 57.11	mm				
Dot size	0.223 x 0.225	mm				
Dot pitch	0.238 x 0.24	mm				
LCD type	FSTN Positive Transflective					
	(In LCD production, It will occur slightly color only guarantee the same color in the same batch.	(In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)				
Duty	1/240					
View direction	6 o'clock					
Backlight	LED, White					
IC	RA8835					
Interface	68/80 series					

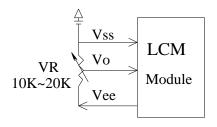
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _{IN}	-0.3	_	V _{DD+0.3}	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	7.0	V
Supply Voltage For LCD	$V_{ m DD}$ - V_0	0	_	32	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Consults Walters Fau I and	$ m V_{DD} ext{-}V_{SS}$	_	3.0	3.3	3.6	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	_	4.7	5.0	5.3	V
Consulta Wilkers FamiliOD		Ta=-20°C	_	_	_	V
Supply Voltage For LCD	$ m V_{OP}$	Ta=25°C	22.7	23.0	23.3	V
*Note		Ta=70°C	_	_	_	V
Input High Volt.	$ m V_{IH}$	_	$0.5V_{DD}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	$0.2V_{DD}$	V
Output High Volt.	V_{OH}	_	V _{DD} -0.4	_	_	V
Output Low Volt.	V_{OL}	_	_	_	V _{SS} +0.4	V
	I_{DD}	V _{DD} =3.3V	_	75	107.5	mA
Supply Current	I_{DD}	V _{DD} =5.0V	_	36	68.5	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

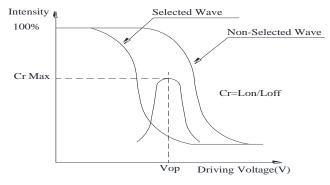


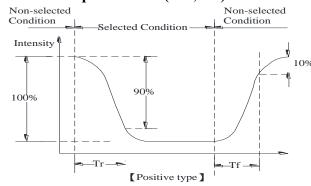
6.Optical Characteristics

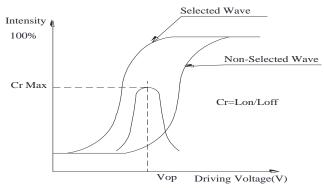
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
77: A1 -	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Danaga Tima	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

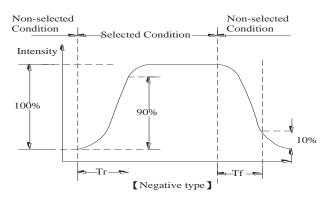
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf) Non-selected Condition









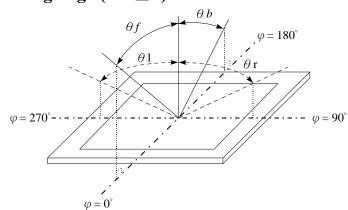
Conditions:

Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

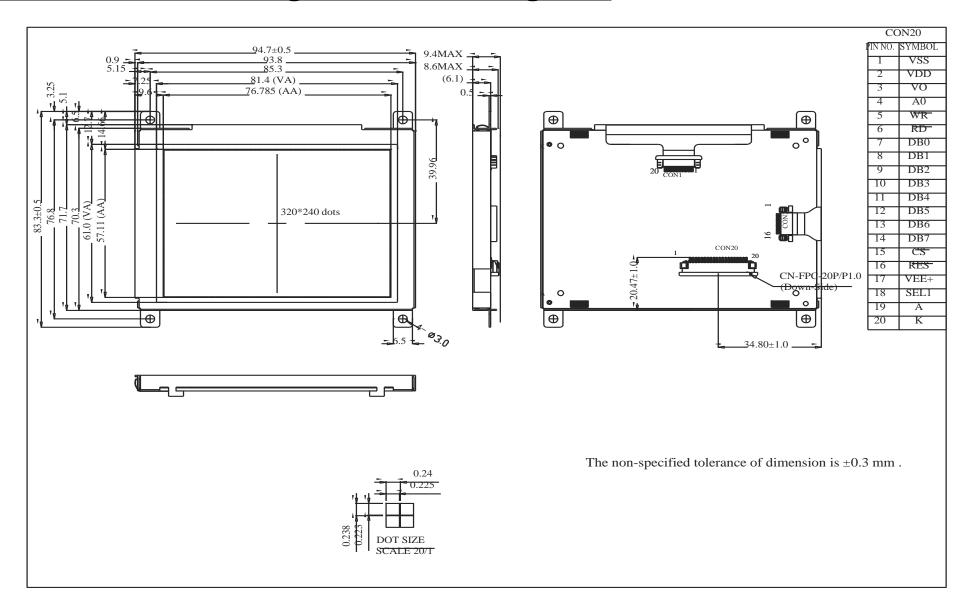
Definition of viewing angle($CR \ge 2$)

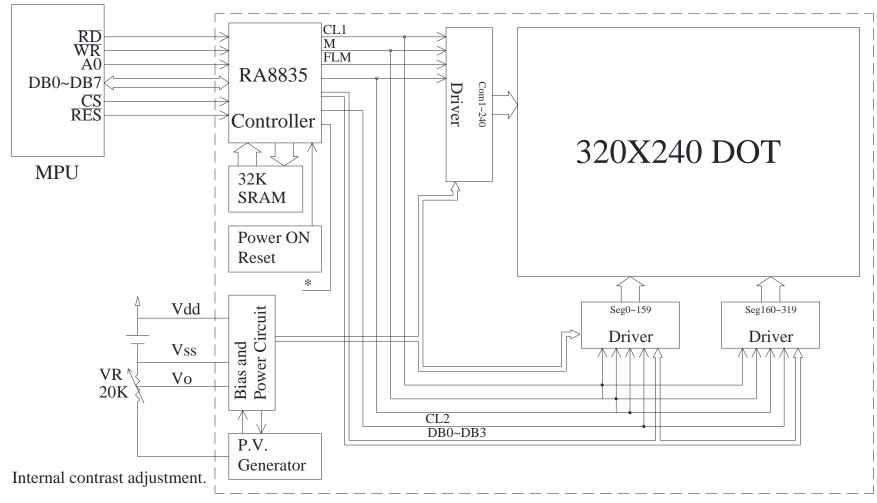


7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	VSS		Ground
2	VDD		Power supply for Logic
3	VO	(Variable)	Operation voltage LCD driving
4	A0	H/L	H:Data L:Instruction
5	/WR	Н	8080 family: Write signal, 6800 family: R/W signal
6	/RD	L	8080 family: Read signal, 6800 family: Enable clock
7-14	DB0-DB7	H/L	DB0 Data bus line
15	/CS	H/L	Chip Enable
16	/RES	H/L	Reset
17	VEE		Positive voltage output
18	SEL1	H/L	8080 OR 6800 Family Interface Select; H:68xx, L:80xx
19	A		Power supply for B/L+
20	K		Power supply for B/L-

8.Contour Drawing & Block Diagram





*:6800 family or 8080family interface selectable.

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test						
Test Item	Content of Test	Test Condition	Not e				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles					
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	2				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= ±600 V(contact), ±800 v(air), RS= 330Ω CS= 150 pF 10 times					

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

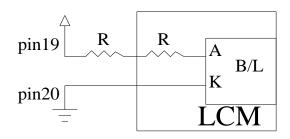
Specification

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED	72	82	120	mA	V=3.5V
Supply Voltage	V	_	3.5	_	V	_
Reverse Voltage	VR	_	_	5	V	_
Chromaticity	X	0.26	0.29	0.32	_	_
Coordinates	Y	0.26	0.29	0.32	_	_
Luminance (Without LCD)	IV	560	700	_	cd/m ²	ILED=82mA
LED Life Time (For Reference only)	-	_	50K	_	Hr.	ILED=82mA 25℃,50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

Drive from pin19,pin20



11.Inspection specification

No	Item			Criterion		AQL		
01	Electrical Testing	Missing character Display malfunction or no function or no Current consumption LCD viewing an						
02	Black or white spots on LCD (display only)	three white or bl	2.1 White and black spots on display ≤0.25mm, no more than hree white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm					
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type: $\Phi = (x + y)/2$ $X \longrightarrow X$ 3.2 Line type: $A = X \times X$	¥ ¥	Size $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ Fing drawing) $Width$ $W \le 0.02$ $0.02 < W \le 0.03$ $0.03 < W \le 0.05$	Acceptable QTY Accept no dense 2 1 0 Acceptable Q TY Accept no dense 2	2.5		
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction	k spot ot easy eck in	0.05 < W Size Φ Φ≤0.20 0.20 < Φ≤0.50 0.50 < Φ≤1.00 1.00 < Φ Total Q TY	As round type Acceptable Q TY Accept no dense 3 2 0 3	2.5		

No	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:				
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area $x \le 1/8a$			
06		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a	2.5	
		Olf there are 2 or more 6.1.2 Corner crack:	chips, x is total length o	of each chip.		
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	x≤1/8a		
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a		
		⊙ If there are 2 or more chips, x is the total length of each chip.				

No	Item	Criterion AQ					
No	Glass	remain and be inspe	y: Chip width t: Glass thickness agth terminal: ode pad: x : Chip le $x \le 1/3$ x : Chip le $x \le 1/3$ x : Chip le $x \le 1/3$ at touches the ITO octed according to a least sealed by	z: Chip is a: LCD	thickness side length $ \begin{array}{c} \textbf{z: Chip thickness} \\ 0 < \textbf{z} \leq \textbf{t} \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ 0 < \textbf{z} \leq \textbf{t} \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ 0 < \textbf{z} \leq \textbf{t} \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ \text{ver 2/3 of the ITO must rminal specifications.} \end{array} $ $ \begin{array}{c} \textbf{x: length} \\ \textbf{x} \leq \textbf{a} \end{array} $	AQL 2.5	

No	Item	Criterion	
07	Cracked glass	The LCD with extensive crack is not acceptable.	
	Backlight elements	8.1 Illumination source flickers when lit.	
0.0		8.2 Spots or scratched that appear when lit must be judged. Using	
08		LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
	PCB、COB	10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10		characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
		v	2.5
		$X * Y \leq 2mm^2$	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	
11	Soldering	or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	
	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
		must be present or look as if it cause the interface pin to sever.	
		12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp								ppm		
Above limited value is set up according to RoHS.										

- 2. Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

		Feedback Sheet	
odule Number:		Page: 1	
1 · Panel Specification:			
1. Panel Type:	Pass	□ NG ,	
2. View Direction:	Pass	□ NG ,	
3. Numbers of Dots:	Pass	□ NG ,	
4. View Area:	Pass	□ NG ,	
5. Active Area:	Pass	□ NG ,	
6. Operating Temperature:	Pass	□ NG ,	
7. Storage Temperature:	Pass	□ NG ,	
8. Others:			
2 · Mechanical Specification :			
1. PCB Size:	Pass	□ NG ,	
2. Frame Size:	Pass	□ NG ,	
3. Materal of Frame:	Pass	□ NG ,	
4. Connector Position:	Pass	□ NG ,	
5. Fix Hole Position:	Pass	□ NG ,	
6. Backlight Position:	Pass	□ NG ,	
7. Thickness of PCB:	Pass	□ NG ,	
8. Height of Frame to PCB:	Pass	□ NG ,	
9. Height of Module:	Pass	□ NG ,	
10. Others:	Pass	□ NG ,	
3 · <u>Relative Hole Size</u> :			
1. Pitch of Connector:	Pass	☐ NG ,	
2. Hole size of Connector:	Pass	☐ NG ,	
3. Mounting Hole size:	Pass	□ NG ,	
4. Mounting Hole Type:	Pass	□ NG ,	
5. Others:	Pass	□ NG ,	
1 · Backlight Specification:			
1. B/L Type:	☐ Pass	□ NG ,	
2. B/L Color:	Pass	□ NG ,	
3. B/L Driving Voltage (Refere	ence for LED	Type): Pass NG,	
4. B/L Driving Current:	Pass	□ NG,	
5. Brightness of B/L:	☐ Pass	□ NG ,	
6. B/L Solder Method:	Pass	□ NG,	
7. Others:	Pass	□ NG ,	

	winstar		
Modu	le Number :		Page: 2
5、	Electronic Characteristics of		
1.	Input Voltage:	Pass	□ NG ,
2.	Supply Current:	Pass	□ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	Pass	\square NG ,
9.	ESD test:	Pass	□ NG ,
10.	Others:	Pass	□ NG ,
6、	Summary :		
	Sales signature:		
	Customer Signature:		Date : / /